

## SPECIFICATIONS

Architecture		
Physical	Dimensions	Single module, mid-size
		Width: 2.89" (73.5 mm)
		Depth: 7.11" (180.6 mm)
Type	AMC FPGA Carrier	Xilinx FPGA Artix-7 Device
		Single FMC slot
		Dual banks of DDR3 (16-bit each)
Standards		
AMC	Type	AMC.1, AMC.2, and AMC.4 (FPGA programmable)
Module Management	IPMI	IPMI version 2.0
PCle	Lanes	x1 lane via FPGA to AMC
SRIO	Lanes	x1 lane via FPGA to AMC
Configuration		
Power	AMC519	Carrier is ~8W (without mezzanine) application specific
Environmental	Temperature	Operating Temperature: 0° to 65°C (air flow >100LFM)
		Storage Temperature: -40° to +90°C
	Vibration	Operating 9.8 m/s <sup>2</sup> (1.0G), 5 to 500Hz
	Shock	30Gs on each axis
	Relative Humidity	5 to 95 per cent, non-condensing
Front Panel	Interface Connectors	Front panel FMC
	LEDs	IPMI management control
		4 user defined LEDs
	Mechanical	Hot swap ejector handle
Software Support	Operating System	Linux, VxWorks and Windows
Conformal Coating		Humiseal 1A33 Polyurethane (Optional)
		Humiseal 1B31 Acrylic (Optional)
Other		
MTFB		MIL Hand book 217-F @ TBD Hrs
Certifications		Designed to meet FCC, CE and UL certifications where applicable
Standards		VadaTech is certified to both the ISO9001:2000 and AS9100B:2004 standards
Warranty		Two (2) years
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